BD676G, BD676AG, BD678G, BD678AG, BD680G, BD680AG, BD682G, BD682TG

Plastic Medium-Power Silicon PNP Darlingtons

This series of plastic, medium−power silicon PNP Darlington transistors can be used as output devices in complementary general−purpose amplifier applications.

Features

- High DC Current Gain
- Monolithic Construction
- BD676, 676A, 678, 678A, 680, 680A, 682 are complementary with BD675, 675A, 677, 677A, 679, 679A, 681
- BD678, 678A, 680, 680A are equivalent to MJE 700, 701, 702, 703
- These Devices are Pb−Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage BD676G, BD676AG BD678G, BD678AG BD680G, BD680AG BD682G, BD682TG	V_{CEO}	 45 60 80 100	Vdc
Collector-Base Voltage BD676G, BD676AG BD678G, BD678AG BD680G, BD680AG BD682G, BD682TG	V_{CB}	 45 60 80 100	Vdc
Emitter-Base Voltage	V_{EB}	5.0	Vdc
Collector Current	I_C	4.0	Adc
Base Current	I_B	0.1	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	 40 0.32	 W W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction−to−Case	$R_{\theta JC}$	3.13	°C/W

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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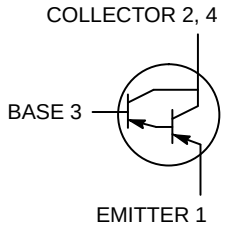
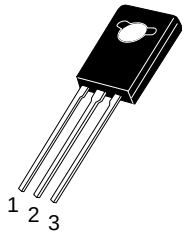
http://onsemi.com

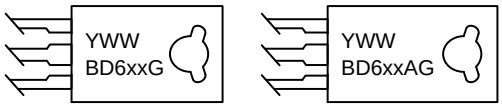
4.0 AMP DARLINGTON POWER TRANSISTORS PNP SILICON 45, 60, 80, 100 VOLT, 40 WATT





TO−225
CASE 77−09
STYLE 1

MARKING DIAGRAMS



Y = Year
WW = Work Week
BD6xx = Device Code
xx = 76, 78, 80, 82, or 82T
G = Pb−Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

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December, 2013 − Rev. 14

Publication Order Number:
BD676/D

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector−Emitter Breakdown Voltage (Note 1) (I_C = 50 mAdc, I_B = 0)	BV_{CEO}			Vdc
BD676G, BD676AG		45	−	
BD678G, BD678AG		60	−	
BD680G, BD680AG		80	−	
BD682G, BD682TG		100	−	
Collector Cutoff Current (V_{CE} = Half Rated V_{CEO}, I_B = 0)	I_{CEO}	−	500	μAdc
Collector Cutoff Current	I_{CBO}			mAdc
(V_{CB} = Rated BV_{CEO}, I_E = 0)		−	0.2	
(V_{CB} = Rated BV_{CEO}. I_E = 0, T_C = 100°C)		−	2.0	
Emitter Cutoff Current (V_{BE} = 5.0 Vdc, I_C = 0)	I_{EBO}	−	2.0	mAdc
ON CHARACTERISTICS				
DC Current Gain (Note 1)	h_{FE}			−
(I_C = 1.5 Adc, V_{CE} = 3.0 Vdc)				
BD676G, BD678G, BD680G, BD682G		750	−	
(I_C = 2.0 Adc, V_{CE} = 3.0 Vdc)				
BD676AG, BD678AG, BD680AG		750	−	
Collector−Emitter Saturation Voltage (Note 1)	$V_{CE(sat)}$			Vdc
(I_C = 1.5 Adc, I_B = 30 mAdc)				
BD678G, BD680G, BD682G		−	2.5	
(I_C = 2.0 Adc, I_B = 40 mAdc)				
BD676AG, BD678AG, BD680AG		−	2.8	
Base−Emitter On Voltage (Note 1)	$V_{BE(on)}$			Vdc
(I_C = 1.5 Adc, V_{CE} = 3.0 Vdc)				
BD678G, BD680G, BD682G		−	2.5	
(I_C = 2.0 Adc, V_{CE} = 3.0 Vdc)				
BD676AG, BD678AG, BD680AG		−	2.5	
DYNAMIC CHARACTERISTICS				
Small−Signal Current Gain (I_C = 1.5 Adc, V_{CE} = 3.0 Vdc, f = 1.0 MHz)	h_{fe}	1.0	−	−

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

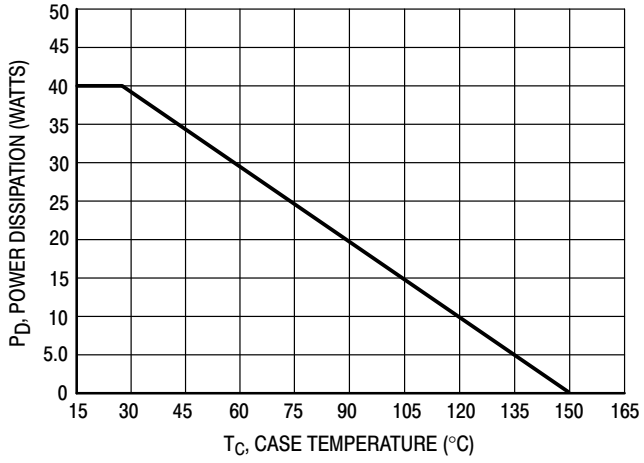

Figure 1. Power Temperature Derating

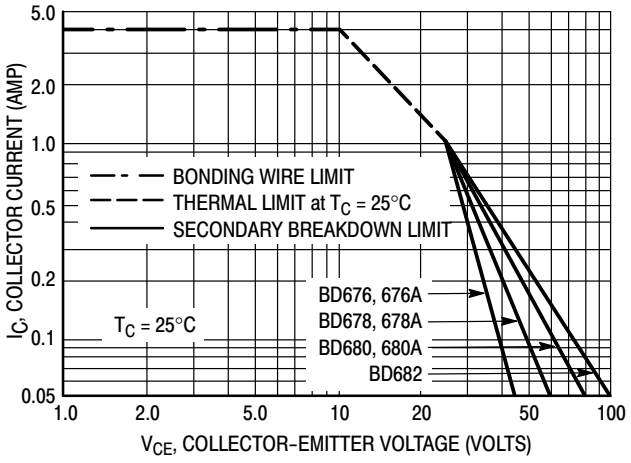

Figure 2. DC Safe Operating Area

There are two limitations on the power handling ability of a transistor average junction temperature and secondary breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; e.g., the transistor must not be subjected to greater dissipation than the curves indicate.

At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by secondary breakdown.

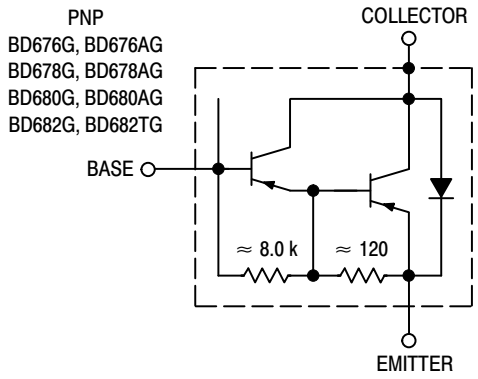

Figure 3. Darlington Circuit Schematic

ORDERING INFORMATION

Device	Package	Shipping
BD676G	TO−225 (Pb−Free)	500 Units / Box
BD676AG	TO−225 (Pb−Free)	500 Units / Box
BD678G	TO−225 (Pb−Free)	500 Units / Box
BD678AG	TO−225 (Pb−Free)	500 Units / Box
BD680G	TO−225 (Pb−Free)	500 Units / Box
BD680AG	TO−225 (Pb−Free)	500 Units / Box
BD682G	TO−225 (Pb−Free)	500 Units / Box
BD682TG	TO−225 (Pb−Free)	50 Units / Rail

MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

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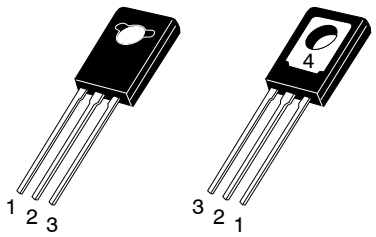
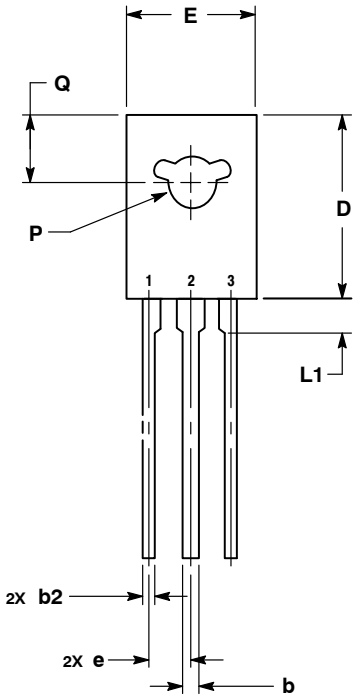
TO−225
CASE 77−09
ISSUE AD

DATE 25 MAR 2015

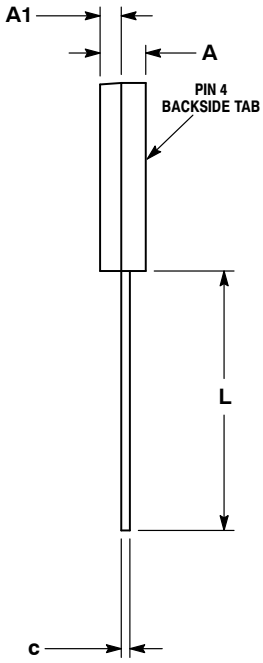


FRONT VIEW **BACK VIEW**

SCALE 1:1



FRONT VIEW

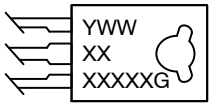


SIDE VIEW

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. NUMBER AND SHAPE OF LUGS OPTIONAL.

	MILLIMETERS	
DIM	MIN	MAX
A	2.40	3.00
A1	1.00	1.50
b	0.60	0.90
b2	0.51	0.88
c	0.39	0.63
D	10.60	11.10
E	7.40	7.80
e	2.04	2.54
L	14.50	16.63
L1	1.27	2.54
P	2.90	3.30
Q	3.80	4.20

GENERIC MARKING DIAGRAM*



Y = Year
WW = Work Week
XXXXX = Device Code
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present.

STYLE 1:
PIN 1. EMITTER
2., 4. COLLECTOR
3. BASE

STYLE 2:
PIN 1. CATHODE
2., 4. ANODE
3. GATE

STYLE 3:
PIN 1. BASE
2., 4. COLLECTOR
3. EMITTER

STYLE 4:
PIN 1. ANODE 1
2., 4. ANODE 2
3. GATE

STYLE 5:
PIN 1. MT 1
2., 4. MT 2
3. GATE

STYLE 6:
PIN 1. CATHODE
2., 4. GATE
3. ANODE

STYLE 7:
PIN 1. MT 1
2., 4. GATE
3. MT 2

STYLE 8:
PIN 1. SOURCE
2., 4. GATE
3. DRAIN

STYLE 9:
PIN 1. GATE
2., 4. DRAIN
3. SOURCE

STYLE 10:
PIN 1. SOURCE
2., 4. DRAIN
3. GATE

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